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## FGA5065ADF 650 V, 50 A Field Stop Trench IGBT

#### Features

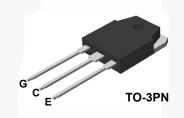
- Maximum Junction Temperature : T<sub>J</sub> = 175<sup>o</sup>C
- Positive Temperaure Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage:  $V_{CE(sat)}$  = 1.7 V(Typ.) @ I<sub>C</sub> = 50 A
- + 100% of the Parts Tested for  $I_{LM}(1)$
- High Input Impedance
- Fast Switching
- Tighten Parameter Distribution
- RoHS Compliant

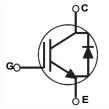
#### **General Description**

This ADF IGBT series adopted field stop trench 3rd generation IGBT which offer extreme low V<sub>CE(sat)</sub> and much faster switching characteristics for outstanding efficiency. And this kind of technology is fully optimized to variety PFC (Power Factor Correction) topology; Single Boost, Multi Channel Interleaved etc with over 20KHz switching performance. TO3P package provide super low thermal resistance for much wider SOA for system stability.

#### Applications

 PFC topology for home applicnce: Single Boost, Multi Channel Interleaved etc.





#### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Description		FGA5065ADF	Unit
V <sub>CES</sub>	Collector to Emitter Voltage		650	V
M	Gate to Emitter Voltage		± 20	V
V <sub>GES</sub>	Transient Gate to Emitter Voltage		± 30	V
I <sub>C</sub>	Collector Current	@ T <sub>C</sub> = 25°C	100	А
10	Collector Current	@ T <sub>C</sub> = 100°C	50	А
I <sub>LM (1)</sub>	Pulsed Collector Current	@ T <sub>C</sub> = 25°C	150	А
I <sub>CM (2)</sub>	Pulsed Collector Current		150	А
	Diode Forward Current	@ T <sub>C</sub> = 25°C	40	А
I <sub>F (3)</sub>	Diode Forward Current	@ T <sub>C</sub> = 100°C	20	А
I <sub>FM (2)</sub>	Pulsed Diode Maximum Forward Cu	rrent	120	А
PD	Maximum Power Dissipation	@ T <sub>C</sub> = 25°C	268	W
• D	Maximum Power Dissipation	Maximum Power Dissipation $@T_{C} = 100^{\circ}C$		W
TJ	Operating Junction Temperature		-55 to +175	°C
T <sub>stg</sub>	Storage Temperature Range		-55 to +175	°C
Τ <sub>L</sub>	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C

#### Notes:

1. V<sub>CC</sub> = 400 V, V<sub>GE</sub> = 15 V, I<sub>C</sub> =150 A, R<sub>G</sub> = 55.9  $\Omega$ , Inductive Load.

2. Repetitive rating: Pulse width limited by max. junction temperature.

3. The purpose of diode is protection for negative voltage.

August 2015

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#### Thermal Characteristics

Symbol	Parameter	FGA5065ADF	Unit	
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case, Max.	0.56	°C/W	
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case, Max.	1.71	°C/W	
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient, Max.	40	°C/W	

## Package Marking and Ordering Information

Part Number	Top Mark	Package	Packaging Method	Reel Size	Tape Width	Quantity
FGA5065ADF	FGA5065ADF	TO-3PN	Tube	-	-	30

## Electrical Characteristics of the IGBT T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	toristics					
BV <sub>CES</sub>	Collector to Emitter Breakdown Voltage	V <sub>GE</sub> = 0V, I <sub>C</sub> = 1 mA	650	-	-	V
ΔBV <sub>CES /</sub> ΔT <sub>.1</sub>	Temperature Coefficient of Breakdown Voltage	$I_{\rm C}$ = 1 mA, Reference to 25°C	-	0.58	-	V/ºC
I <sub>CES</sub>	Collector Cut-Off Current	V <sub>CE</sub> = V <sub>CES</sub> , V <sub>GE</sub> = 0 V	-	-	250	μA
I <sub>GES</sub>	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
On Charac	teristics				•	
V <sub>GE(th)</sub>	G-E Threshold Voltage	I <sub>C</sub> = 50 mA, V <sub>CE</sub> = V <sub>GE</sub>	4.1	5.6	7.6	V
0 = (0.1)		I <sub>C</sub> = 50 A, V <sub>GE</sub> = 15 V	-	1.7	2.2	V
V <sub>CE(sat)</sub>	Collector to Emitter Saturation Voltage	$I_{\rm C}$ = 50 A, $V_{\rm GE}$ = 15 V, T <sub>C</sub> = 175°C	-	2.28	-	V
Dynamic C	haracteristics					
C <sub>ies</sub>	Input Capacitance		-	1995	-	pF
C <sub>oes</sub>	Output Capacitance	V <sub>CE</sub> = 30 V <sub>,</sub> V <sub>GE</sub> = 0 V, f = 1MHz	-	70	-	pF
C <sub>res</sub>	Reverse Transfer Capacitance		-	23	-	pF
Switching	Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time		-	20.8	-	ns
t <sub>r</sub>	Rise Time		-	41.6	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>CC</sub> = 400 V, I <sub>C</sub> = 50 A,	-	62.4	-	ns
t <sub>f</sub>	Fall Time	R <sub>G</sub> = 6 Ω, V <sub>GE</sub> = 15 V,	-	11.2	-	ns
Eon	Turn-On Switching Loss	Inductive Load, $T_C = 25^{\circ}C$	-	1350		uJ
E <sub>off</sub>	Turn-Off Switching Loss		-	309	-	uJ
E <sub>ts</sub>	Total Switching Loss		-	1659	-	uJ
t <sub>d(on)</sub>	Turn-On Delay Time		-	19.2	-	ns
t <sub>r</sub>	Rise Time		-	38.4	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>CC</sub> = 400 V, I <sub>C</sub> = 50 A,	-	67.2	-	ns
t <sub>f</sub>	Fall Time	$R_G = 6 \Omega$ , $V_{GE} = 15 V$ , Inductive Load, $T_c = 175^{\circ}C$	-	12.8	-	ns
E <sub>on</sub>	Turn-On Switching Loss	Inductive Load, T <sub>C</sub> = 175 <sup>o</sup> C	-	1820	-	uJ
E <sub>off</sub>	Turn-Off Switching Loss		-	558	-	uJ
E <sub>ts</sub>	Total Switching Loss			2378		uЈ

## Electrical Characteristics of the IGBT (Continued)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max	Unit
Qg	Total Gate Charge	V <sub>CE</sub> = 400 V, I <sub>C</sub> = 50 A, V <sub>GE</sub> = 15 V	-	72.2	-	nC
Q <sub>ge</sub>	Gate to Emitter Charge		-	13.5	-	nC
Q <sub>gc</sub>	Gate to Collector Charge		-	28.5	-	nC

## Electrical Characteristics of the Diode T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Test Conditio	ons	Min.	Тур.	Max	Unit
$V_{FM}$	Diode Forward Voltage	I <sub>F</sub> = 20 A	T <sub>C</sub> = 25 <sup>o</sup> C	-	2.1	2.6	V
			T <sub>C</sub> = 175 <sup>o</sup> C	-	1.94	-	
E <sub>rec</sub>	Reverse Recovery Energy		T <sub>C</sub> = 175 <sup>o</sup> C	-	50	-	uJ
t <sub>rr</sub> Diod	Diode Reverse Recovery Time	I <sub>F</sub> =20 A, dI <sub>F</sub> /dt = 200 A/μs	T <sub>C</sub> = 25 <sup>o</sup> C	-	31.8	-	ns
			T <sub>C</sub> = 175 <sup>o</sup> C	-	192	-	
Q <sub>rr</sub>	Diode Reverse Recovery Charge		T <sub>C</sub> = 25 <sup>o</sup> C	-	50.6	-	nC
Su	Diodo Novoloo Nooovory enalgo		T <sub>C</sub> = 175 <sup>o</sup> C	-	699	-	

#### **Typical Performance Characteristics**

#### Figure 1. Typical Output Characteristics

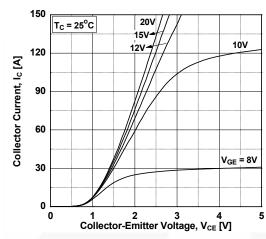


Figure 3. Typical Saturation Voltage Characteristics

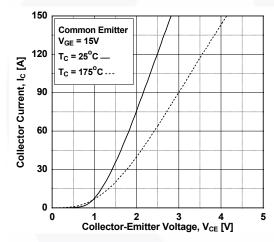


Figure 5. Saturation Voltage vs. V<sub>GE</sub>

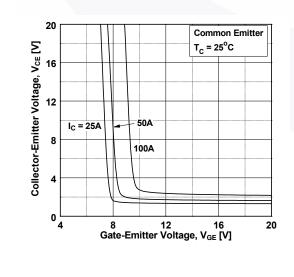
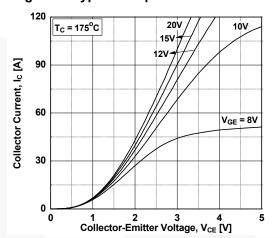


Figure 2. Typical Output Characteristics





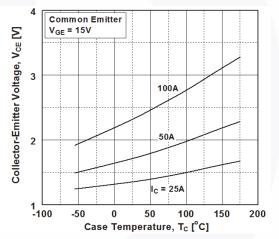
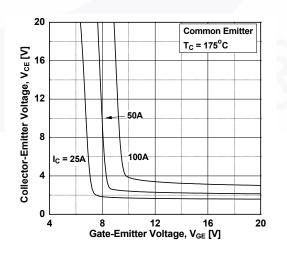
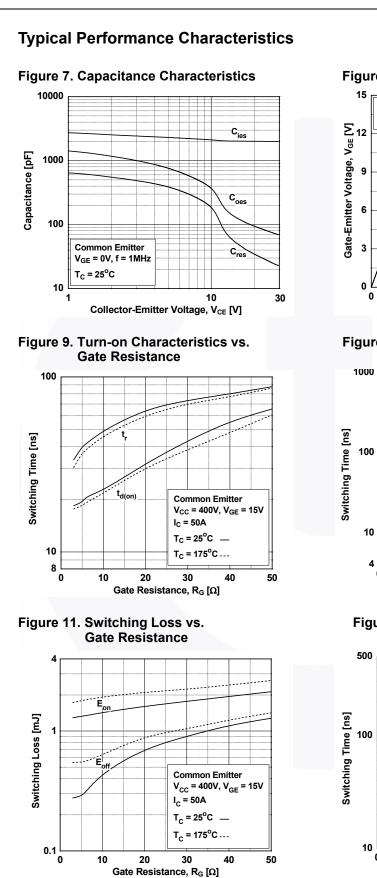
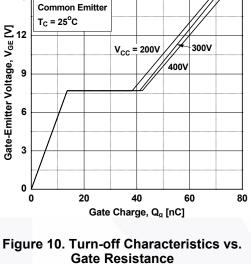


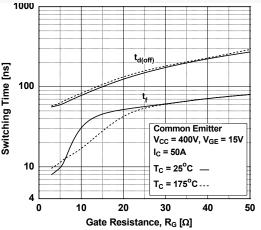
Figure 6. Saturation Voltage vs. V<sub>GE</sub>



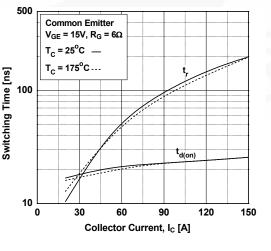


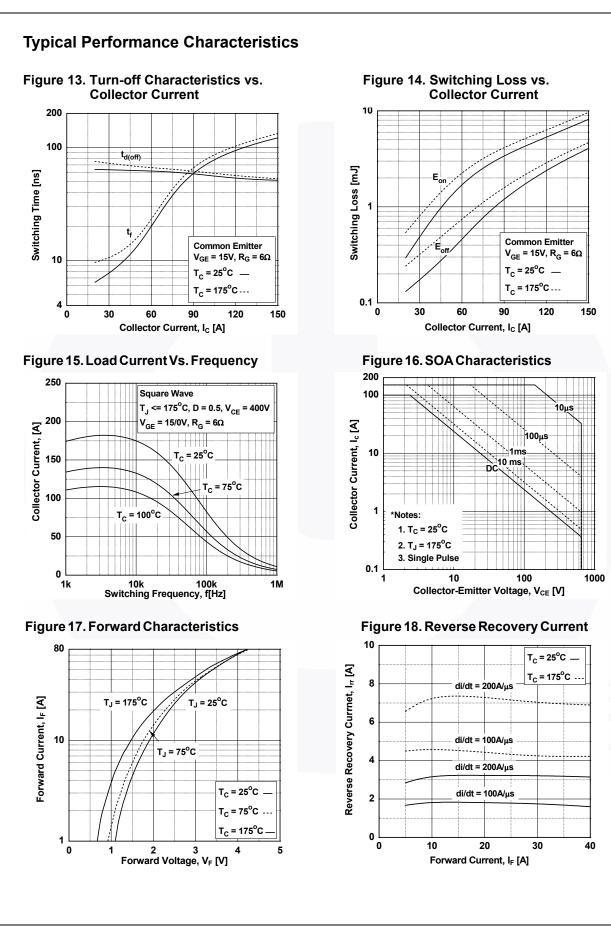
#### Figure 8. Gate charge Characteristics

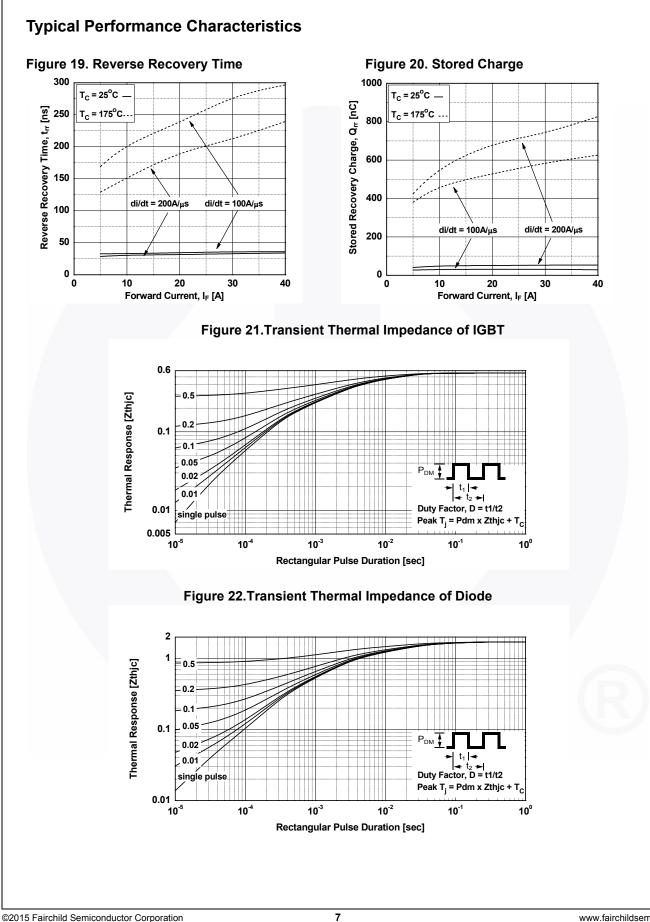


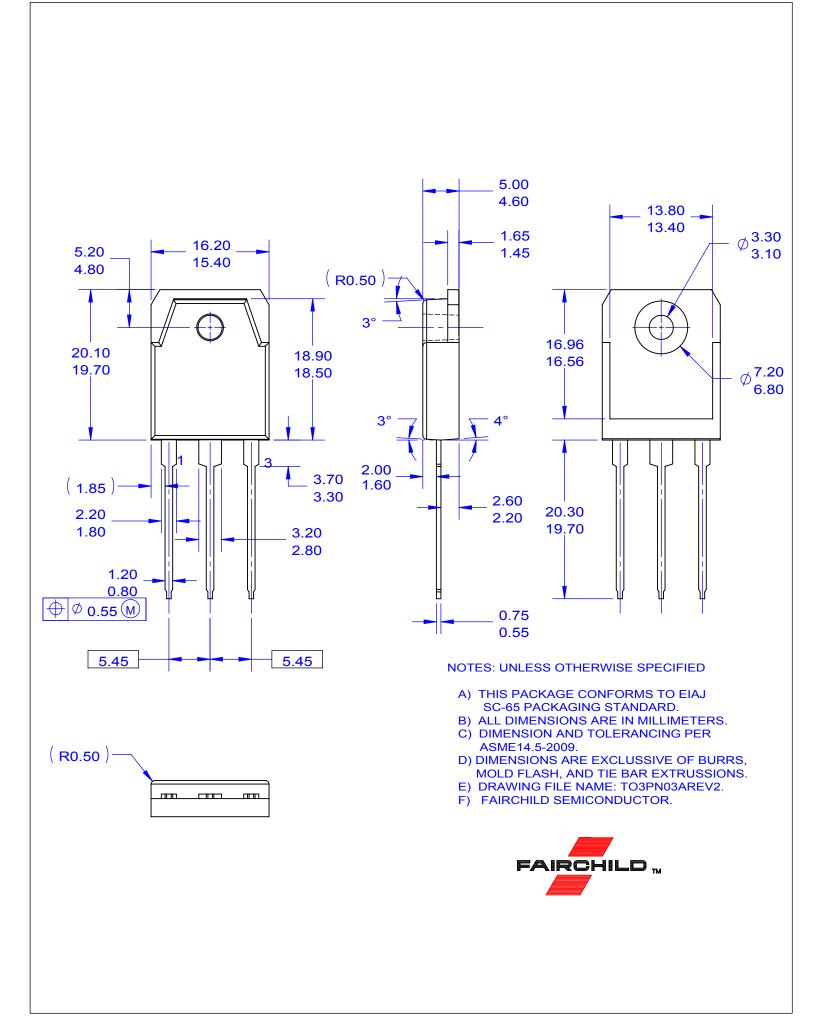












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